

#### Is Now Part of



# ON Semiconductor®

# To learn more about ON Semiconductor, please visit our website at www.onsemi.com

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to Fairchild <a href="general-regarding-numbers-n

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officer



**April 2016** 

# FFPF10F150S 10 A, 1500 V, Damper Diode

#### **Features**

- High Speed Recovery  $t_{rr}$  = 170 ns (@  $I_F$  = 1 A)
- Max Forward Voltage, V<sub>F</sub> = 1.6 V (@ T<sub>C</sub> = 25°C)
- 1500 V Reverse Voltage and High Reliability
- Low Forward Voltage

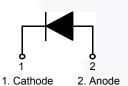
### **Applications**

• Suitable for Damper Diode in Horizontal Deflection Circuits

### **Pin Assignments**



1. Cathode 2. Anode



#### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

| Symbol                           | Parameter   | Rating       | Unit |
|----------------------------------|---|--------------|------|
| V <sub>RRM</sub>                 | Peak Repetitive Reverse Voltage                                 | 1500         | V    |
| $V_{RWM}$                        | Working Peak Reverse Voltage                                    | 1500         | V    |
| I <sub>F(AV)</sub>               | Average Rectified Forward Current @ T <sub>C</sub> = 125 °C     | 10           | Α    |
| I <sub>FSM</sub>                 | Non-repetitive Peak Surge Current<br>60Hz Single Half-Sine Wave | 100          | Α    |
| T <sub>J,</sub> T <sub>STG</sub> | Operating Junction and Storage Temperature                      | - 65 to +150 | °C   |

### Thermal Characteristics T<sub>C</sub> = 25°C unless otherwise noted

| Symbol          | Parameter                                    | Max. | Unit |
|-----------------|--|------|------|
| $R_{\theta JC}$ | Maximum Thermal Resistance, Junction to Case | 3.0  | °C/W |

### Package Marking and Ordering Information

| Part Number   | Top Mark | Package    | Packing Method | Reel Size | Tape Width | Quantity |
|---------------|----------|------------|----------------|-----------|------------|----------|
| FFPF10F150STU | F10F150S | TO-220F-2L | Tube           | N/A       | N/A        | 30       |

### Electrical Characteristics T<sub>C</sub> = 25°C unless otherwise noted

| Parameter                   | Conditions   |   |   | Тур. | Max.       | Unit |
|-----------------------------|--|---|---|------|------------|------|
| V <sub>F</sub> <sup>1</sup> | Maximum Instantaneous Forward Voltage $I_F = 10 \text{ A}$ $I_F = 10 \text{ A}$                                    | T <sub>C</sub> = 25 °C<br>T <sub>C</sub> = 125 °C |   | -    | 1.6<br>1.4 | ٧    |
| I <sub>R</sub> <sup>1</sup> | Maximum Instantaneous Reverse Current @ rated V <sub>R</sub>   | T <sub>C</sub> = 25 °C<br>T <sub>C</sub> = 125 °C |   |      | 10<br>80   | μΑ   |
| t <sub>rr</sub>             | Maximum Reverse Recovery Time $(I_F = 1 \text{ A, di}_F/\text{dt} = 50 \text{ A/}\mu\text{s, V}_R = 30 \text{ V})$ |   | - | -    | 170        | ns   |
| t <sub>fr</sub>             | Maximum Forward Recovery Time (I <sub>F</sub> = 6.5 A, di <sub>F</sub> /dt = 50 A/µs)                              |   | - | -    | 250        | ns   |
| V <sub>FRM</sub>            | Maximum Forward Recovery Voltage   |   | - | -    | 14         | V    |

#### Notes:

1. Pulse : Test Pulse Width =  $300\mu s$ , Duty Cycle = 2%

#### **Test Circuit and Waveforms**

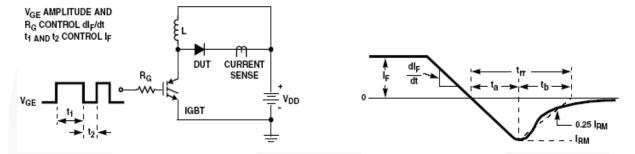


Figure 1. Diode Reverse Recovery Test Circuit & Waveform

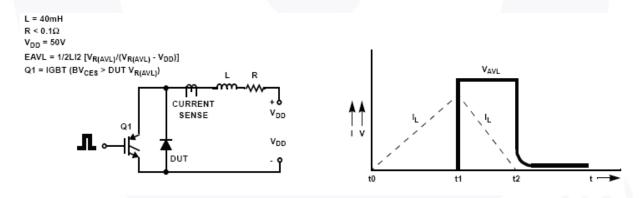
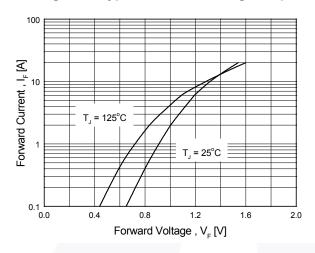


Figure 2. Unclamped Inductive Switching Test Circuit & Waveform

### Typical Performance Characteristics T<sub>C</sub> = 25°C unless otherwise noted

Figure 3. Typical Forward Voltage Drop



**Figure 4. Typical Reverse Current** 

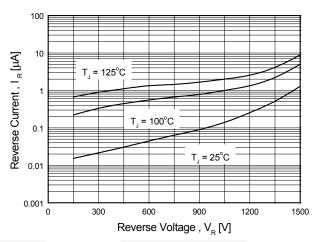


Figure 5. Typical Junction Capacitance

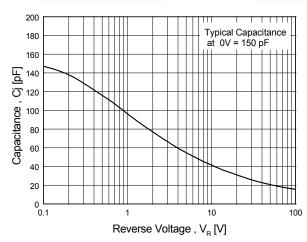


Figure 6. Typical Reverse Recovery Time

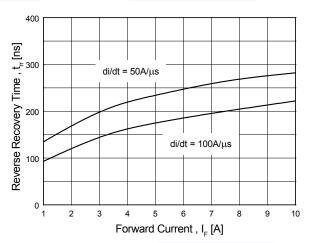
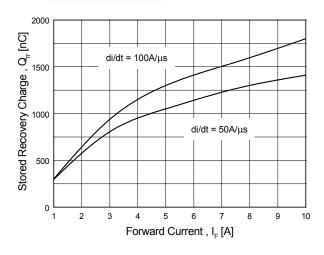
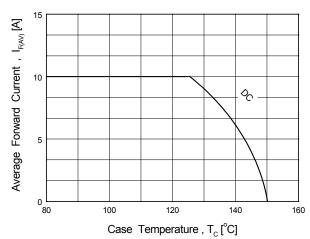


Figure 7. Typical Stored Charge

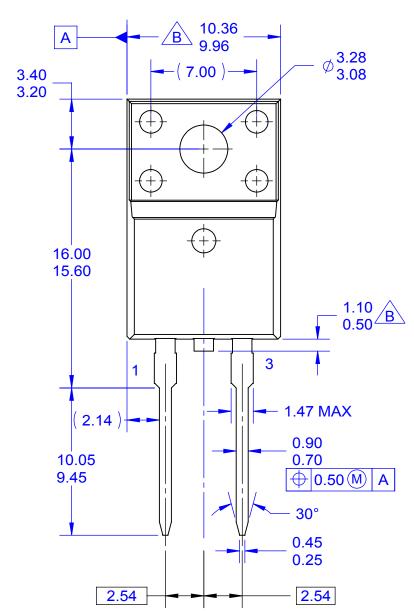


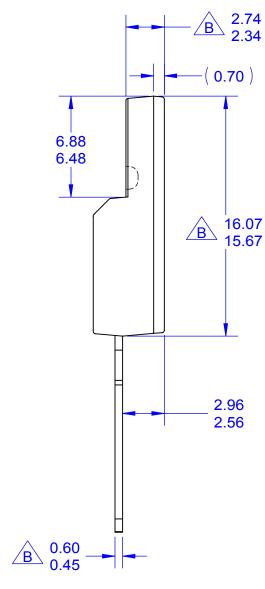
**Figure 8. Forward Current Deration Curve** 



THIS DRAWING IS THE PROPERTY OF FAIRCHILD SEMICONDUCTOR CORPORATION. NO USE THEREOE SHALL BE MADE OTHER THAN AS A REFERENCE FOR PROPOSALS AS SUBMITTED TO FARRCHILD SEMICONDUCTOR CORPORATION FOR JOSS TO BE EXECUTED IN CONFORMITY WITH DESCRIPTION OF THE PROPERTY OF SHAD FAIRCHILD SEMICONDUCTOR COR-PORATION HAVE PREVIOUSLY BEEN DATABLED. NO FAIR OF THIS DRAWING SHALL BE COPIED OR DUFFLICATED OR TIS CONTENTS BESILDED. THE INFORMATION CONTAINED ON THIS DRAWING IS CONFIDENTIAL AND PROPERTY.

|                           | REVISIONS       |         |                |  |  |
|---------------------------|-----------------|---------|----------------|--|--|
| NBR DESCRIPTION DATE BY/A |                 |         |                |  |  |
| 1                         | RELEASED TO DCC | 08JUL08 | H.ALLEN.FSME   |  |  |
| 2                         | COMPLETE REDRAW | 14APR09 | KH LEE/ SUZHOU |  |  |





### NOTES:

4.90

4.50

/B

- A. EXCEPT WHERE NOTED CONFORMS TO EIAJ SC91A.
- B DOES NOT COMPLY EIAJ STD. VALUE.
- C. ALL DIMENSIONS ARE IN MILLIMETERS. D. DIMENSIONS ARE EXCLUSIVE OF BURRS,
- D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
- E. DIMENSION AND TOLERANCE AS PER ASME Y14.5-1994.
- F. DRAWING FILE NAME: TO220C02REV2

| APPROVALS                 | DATE    | FAIRCHILD                   |  |  |
|---------------------------|---------|-----------------------------|--|--|
| DRAWN: BOBOY MALDO        | 14APR09 |                             |  |  |
| CHECKED: KH LEE           |         | SEMICONDUCTOR™              |  |  |
| APPROVED: BY HUANG        |         | 2LD, TO220,                 |  |  |
| APPROVED:<br>HOWARD ALLEN |         | MOLDED, FULL PACK           |  |  |
| PROJECTION                |         | 1:1 N/A MKT-TO220C02 2      |  |  |
| [MM]<br>INCH              |         | FORMERLY: N/A SHEET: 1 OF 1 |  |  |

ON Semiconductor and in are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdt/Patent-Marking.pdf">www.onsemi.com/site/pdt/Patent-Marking.pdf</a>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and exp

#### **PUBLICATION ORDERING INFORMATION**

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada
Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81–3–5817–1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

ON Semiconductor: FFPF10F150STU